

# Vertiv<sup>™</sup> Liebert<sup>®</sup> XDU070

70kW Liquid-to-Air Coolant Distribution Unit



## Efficiently Deploy Liquid-Cooled Servers in Any Data Center Environment

Vertiv<sup>™</sup> Liebert<sup>®</sup> XDU070 is a coolant distribution unit that allows you to easily and cost-effectively tap into the advantages of liquid cooling. By utilizing a liquid-to-air heat exchanger, it eliminates the need for facilities water and removes the traditional barriers to liquid cooling!

Artificial Intelligence, Machine Learning, and other data-intensive technologies like Virtual Reality are requiring data centers and colocation environments to deploy servers with ever-higher power and cooling requirements. While liquid-cooled servers afford tremendous efficiency benefits in these high-density environments, it is no small task for an air-cooled data center to make the infrastructure changes needed to support liquidcooled servers. Until now.

#### Liquid Cooling Solution for Air-Cooled Environments

The Liebert® XDU070 makes it possible for data centers to deploy liquid cooled servers without extensive updates to existing infrastructure. The row-based heat exchanger is an easy-to-deploy, fully-enclosed system that is filled at the time of installation and mounted adjacent to or nearby a rack of liquid-cooled servers.

A secondary fluid network (SFN) running from the XDU070 to the racks is controlled by variable speed pumps to deliver just enough cooling capacity to support the liquid cooled servers. The liquid-to-air heat exchanger then rejects the heat into the data center to match your facility's current air-cooling configuration, seamlessly integrating with existing thermal management solutions.

## **Key Benefits**

- Significantly reduces the capital expense associated with liquid cooling in an air-cooled environment by eliminating the need for facilities water.
- Easily and quickly installs and deploys in any data center environment with in-row or perimeter placement options that don't require valuable rack space.
- Delivers exceptional chip cooling heat rejection capacity (70+ kW) to accommodate high-density racks.
- Ensures cooling reliability and efficiency with redundant pump design, VSD pump controls, and EC fans.
- Easy to control, monitor, service, and maintain system water quality.

### **Liebert XDU070 Features**

#### **Efficient Heat Rejection**

- 70kW+ cooling capacity with full modulation capabilities
- Redundant pumps provide additional reliability
- Variable Speed Drive (VSD) controls and EC fans increase efficiency
- Automatically match supply water temperature to heat load demand

#### **Complete Visibility and Control**

- 7 in. color touchscreen human machine interface (HMI)
- Communications via Modbus RTU (RS485) and TCP/IP
- Full alarm monitoring with real-time status of IT equipment
- Remote monitoring and control
- Unit-to-unit teamworking capabilities for increased redundancy and control
- ARM Cortex M7 based controller

#### Serviceability

- Rapid deployment with in-row installation
- Full service access from front and rear doors
- Easy to install, configure and operate
- Hot-swappable fans, pumps, and filters ensure limited system downtime



## Vertiv<sup>™</sup> Liebert<sup>®</sup> XDU070 Highlights

#### Closed-Loop Pipe Design with Integrated Leak Detection

Operates with limited water volume and hose piping to simplify deployment and protect data center equipment.

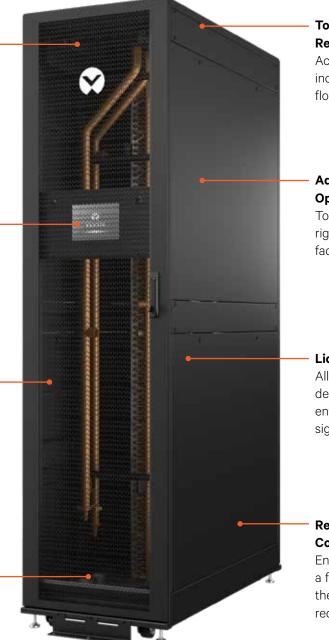
**7" Color Touch Screen Display** With state-of-the-art controls for complete visibility of operating conditions and unit status.

# Closed Loop Fan Speed Control with Extra Capacity

Automatically matches the supply water temperature to the load to eliminate overcooling and boost efficiency.

#### Integrated 50-Micron Filter

Keeps supply water clean to protect server integrity and performance.



# Top or Bottom Liquid Supply & Return Connection

Accommodates any facility design including raised floor and non-raised floor data centers.

#### Adjacent or Remote Placement Options

To channel rejected hot air to the right location to coordinate with the facility's current cooling configuration.

#### Liquid-to-Air Heat Rejection

Allows for high density liquid-cooled deployments in traditionally air-cooled environments without the need for significant infrastructure changes.

#### Redundant Pumps with VSD Control

Ensure reliable, efficient cooling with a flow rate that can be set to meet the data center's specific cooling requirements.

## **Technical Specifications**

### Physical Data

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Unit Dimensions (H x W x D), mm (in)	2300 x 600 x 1200 (91 x 24 x 48)	
Shipping Dimensions (H x W x D), mm (in)	2400 x 1000 x 1400 (94.5 x 39.4 x 55.1)	
Weight (Dry), kg (lbs)	408 (899)	
Weight (Wet), kg (lbs)	457 (1007)	
Weight (Shipping), kg (lbs)	560 (1234)	
Performance Data	at 40°C (104°F) fluid supply temperature (PG2	5)
Nominal Cooling Capacity	70 kW @ 11°C Approach Temperature Difference (ATD)	
Nominal Fluid Flow	60 l/min (15.8 gpm)	
Maximum Cooling Capacity	100 kW @ 20°C ATD	
Maximum Fluid Flow	80 l/min (21.1 gpm)	
Performance Data	at 45°C (113°F) fluid supply temperature (PG2	5)
Nominal Cooling Capacity	70 kW @ 14°C ATD	
Nominal Fluid Flow	80 l/min (21.1 gpm)	
Maximum Cooling Capacity	108 kW @ 25°C ATD	
Maximum Fluid Flow	100 l/min (26.4 gpm)	
*All Performance Data listed above was calculated with 6 fan operation		
Fan Data		
Maximum Airflow, 6 Fan Operation (N+1)	10,100 CMH (5,945 CFM)	
Maximum Airflow, 7 Fan Operation (N)	11,100 CMH (6,533 CFM )	
Noise Level at 3m (10ft)	< 72 dBA (Sound Pressure)	
Fluid Circuit Data		
Fluid Type	Water or PG-25 with inhibitors	
Fluid Filtration	50µ	
Total Water Volume	6.2 gal	
Base Unit, L (Gal)	39 (10.3)	
Reservoir Tank Capacity, L (Gal)	10 (2.6)	
Piping Connection, Top and Bottom	1.5 in. Sanitary Flange	
Electrical Data		
Power Supply	115V, 1PH, 60Hz	230V, 1PH, 50HZ
Full Load Amps (FLA)	16A	8A
Minimum Circuit Ampacity (MCA)	24A	20A
Overcurrent Protection Device (OPD)	40A	32A
Nominal Power Consumption	1.7 kW (at maximum flow and external pressure drop)	
Max Installed Load	3.91 kVA	
Dual Power Feeds (with ATS)	Standard Feature	
*Contact Vertiv for additional power configurations		
Ambient Conditions		
Operating Conditions	0 to 40° C (32 - 104° F), 10 to 90% RH (non-condensing)	
Storage Conditions	-40 to 70° C (-40 - 158°F), 5 to 93% RH (non-condensing)	
Compliance		
Safety Compliance	CE, cULus (pending), RoHS	



### **Related Liquid Cooling Solutions**



#### Vertiv™ Liebert® DCD Rear Door Heat Exchanger

Capacity: 35, 47, and 50 kW Type: Active and Passive Key Applications: Hyperscale, Enterprise, Colocation, Finance, Government, Media & Entertainment

**Scalable Cooling Capacity:** allows for 0-100% modulation, meeting the everchanging demands of the system. Available as active or passive models.

**Rear-Door Mounting:** reduces physical space required to deploy, saving valuable floorspace for addition racks for critical IT equipment.

**Room-Neutral Cooling:** removes heated air as it passes through the door, delivering room temperature air back into the data center.



#### Vertiv<sup>™</sup> Liebert<sup>®</sup> XDM Split Indoor Chiller

Capacity: 200 kW Type: Pumped Refrigerant Key Applications: Hyperscale, Enterprise, Colocation, Finance, Government, Media & Entertainment

#### **Pumped Refrigerant Economization**

**(PRE):** efficiently and reliably cools pods of high-density racks without the need for chilled water.

Variable Speed Pumps: allow for variation in flow of PRE based on load demand, increasing efficiency and saving energy dollars.

**Modular Design:** supports efficiency and redundancy needs by allowing units to function independently or in teamwork mode.

**Standard Footprint:** that mirrors the size of air-cooled Vertiv<sup>™</sup> Liebert<sup>®</sup> DSE units, simplifying retrofits and future-proofing new data center designs.



#### Vertiv™ Liebert® XDU Coolant Distribution Unit

Capacity: 450 and 1350 kW Type: Liquid-to-Liquid CDU Key Applications: Hyperscale, Enterprise, Colocation, Finance, Government, Media & Entertainment

**Wide Cooling Capacity Range:** from 450-1350kw of cooling capacity to accommodate customer facility design & performance requirements.

**Stable Thermal management:** Precise temperature control to eliminate thermal shock for CPU and GPUs.

**Closed-Loop Design:** with hygienic couplings and leak detection helps ensure SFN integrity with strictly controlled water quality.

#### **Redundant Pumps and Dual Power**

Feeds: for optimizing reliable operation.



Vertiv.com | Vertiv Headquarters, 505 N. Cleveland Ave, Columbus, OH, 43082, USA

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